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Board Of Education[®] USB (#28850)

Development / Education Platform for the BASIC Stamp[®] and Javelin Stamp Microcontrollers

The Board Of Education USB (BOE-USB) is a complete, low-cost development platform designed for those interested in learning and using Parallax's 24-pin BASIC Stamp or Javelin Stamp modules. Its compact size, convenient features, and low price make it an ideal tool for the student and educator. The BOE-USB is a great tool with which to get started with Parallax BASIC Stamp ICs. For educators, the BOE provides a clean, efficient platform for our Stamps In Class Parts and Text Kits, or your own BASIC Stamp-based curriculum.

Features

- 2.1 mm center-positive plug and 9-volt battery power supply connections (mechanically interlocked to prevent dual connection). Note: The USB-BOE is not powered from the USB connection.
- Three-position power switch allows BASIC Stamp IC programming without providing power to servo connectors.
- Jumper selection of servo power: regulated (Vdd) or unregulated (Vin).
- Mini USB connector for BASIC Stamp IC programming and serial communication during run-time.
- On-board regulator delivers up to 1 amp of power for larger projects.
- P0 - P15 I/O pins, Vdd, Vin, and Vss connections brought adjacent to 2" x 1 3/8" breadboard area.
- Female 10-pin dual row connector for optional AppMods.

Packing List

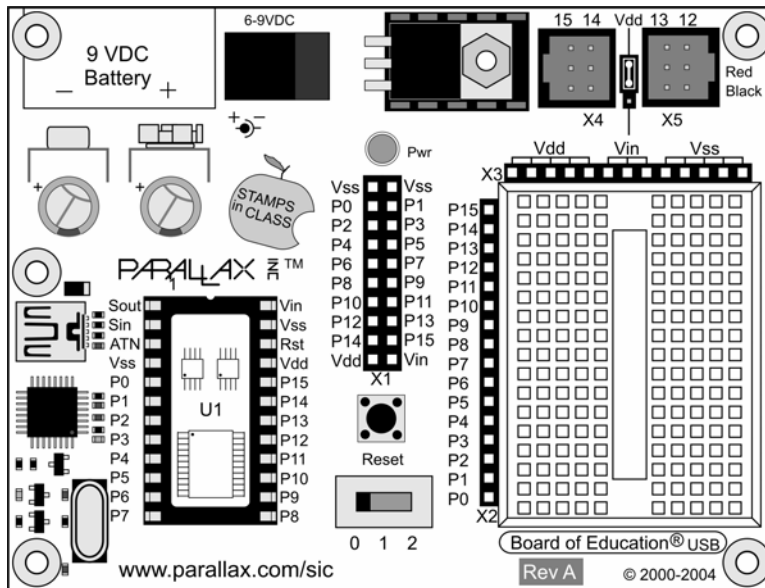
- | | |
|---------------------------|------------|
| • BOE-USB | #800-28850 |
| • Pack of 3" jumper wires | #800-00016 |
| • PCB rubber feet | #700-00037 |
| • Documentation | |

Note: Demonstration software and FTDI VCP drivers may be downloaded from www.parallax.com; see the USB Virtual Com Port (VCP) Driver Installation section on page 4.

Mechanical Dimensions

- | | |
|------------------|--------------------------------|
| • PCB | 4.00" x 3.05" (102 mm x 77 mm) |
| • Mounting Holes | 3.75" x 2.75" (95 mm x 70 mm) |

Board of Education USB – Top View (without BASIC Stamp module)



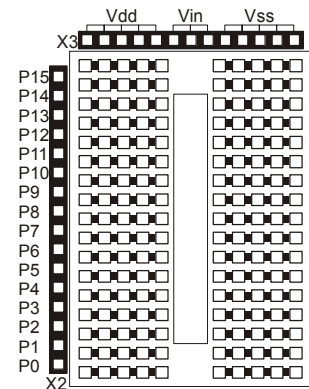
Board Revisions

All revisions of the BOE-USB are functionally equivalent to the serial BOE Rev C. When using the BOE-USB with titles in the Stamps in Class series, follow the directions given for the Board of Education Rev C. Do not follow the directions given for the serial Board of Education Rev A or Rev B.

Using the BOE-USB Breadboard

The breadboard has many strips of copper which run underneath the board in a horizontal fashion. These strips connect the sockets to each other. This makes it easy to connect components together to build circuits.

To use the breadboard, the legs of components or wires are placed in the sockets. The sockets are made so that they will hold the component in place. Each hole is connected to one of the metal strips running underneath the board. Each metal strip forms a node. A node is a point in a circuit where two components are connected. Connections between different components are formed by putting their legs in a common node. There are two columns of 17 nodes on the breadboard. Each node contains five holes.



For chips with many legs (ICs), place them in the middle of the board so that half of the legs are on the left side and half are on the right side. Nodes on the left side are not connected to nodes on the right side.

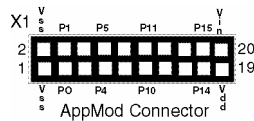
BASIC Stamp IC I/O Access, Vdd, Vin, and Vss

The BASIC Stamp IC's 16 I/O pins are brought to the X2 female socket left of the breadboard. I/O pins are accessed by plugging wires into the header, then into the breadboard sockets. The X3 socket provides four connection points for a +5V (Vdd) connection, unregulated input voltage (Vin), and ground (Vss).

AppMod Header

The AppMod header provides a connection and signal routing for additional modules. Some of the AppMods available from Parallax are:

- EmbeddedBlue Transceiver
- Sound Module
- LCD Terminal
- RS-232 DCE Module



All I/O pins, Vdd, Vin, and Vss are routed through the AppMod connector.

USB Virtual Com Port (VCP) Driver Installation

Older operating systems may require installation of the FTDI VCP driver before using the BOE-USB. The latest VCP drivers and installation instructions are available separately at this URL:

http://www.parallax.com/detail.asp?product_id=28850

BASIC Stamp Editor Identification: Echo and Loopback

The BASIC Stamp Editor's Run → Identify function is used to verify the connection between your computer and your BASIC Stamp Module. Communication is confirmed by a "Yes" in both the Loopback and Echo columns. However, when using USB-based communication, such as with the BOE-USB, the Loopback column does not always give reliable results. When using the BOE-USB, a "YES" in the Echo column is usually a confirmation of communication, and the Loopback status can simply be ignored.

